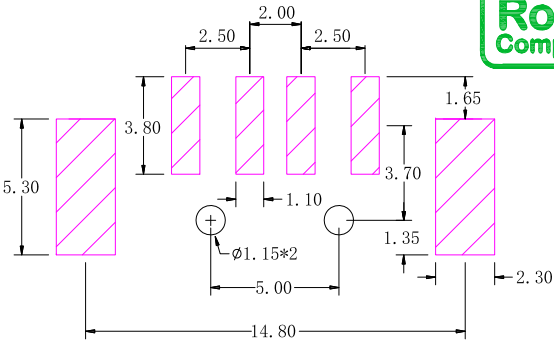




SUA-110M15-x-x-S175

鍍層厚度 :	COLOR :
Blank : 1u"	Black : B
2 : 15u"	White : W
3 : 30u"	Blue : BL



PCB LAYOUT MOUNTING PATTERN

SPECIFICATIONS

Electrical:

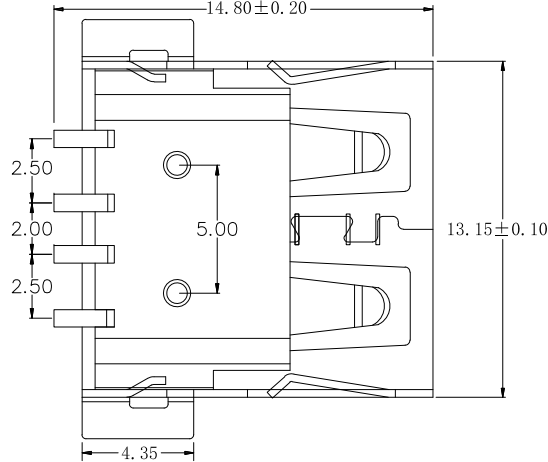
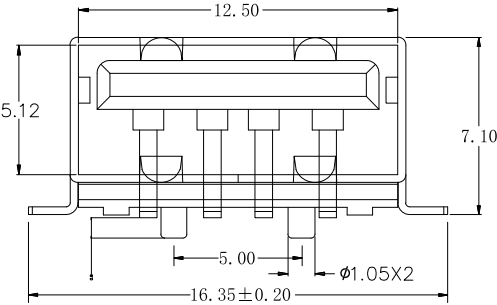
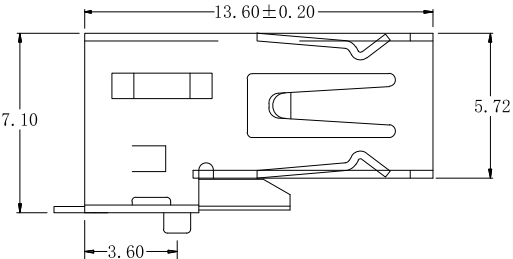
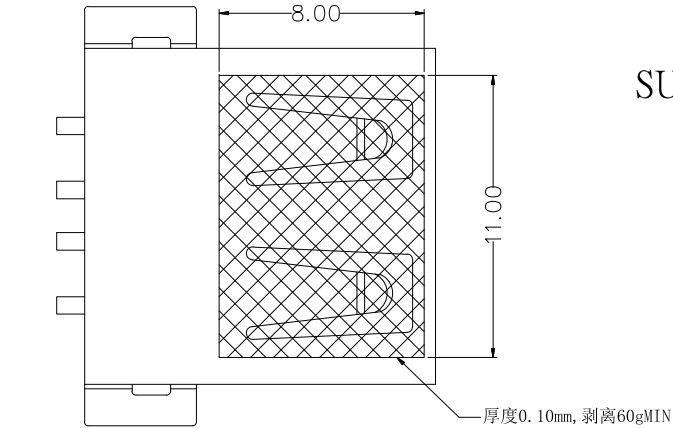
- 1.Current Rating: 1.5A / contact terminal
- 2.Voltage Rating: 30V DC
- 3.Contact Resistance: 30 mΩ Max
- 4.Dielectric Withstanding Voltage: 500 V AC AT Sec Level
- 5.Insulation Resistance: 1000 MΩ Min

Material:

- 1.Housing: LCP , Black
- 2.Contact: BRASS
- 3.Shell: BRASS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



CONTACT		建倚科技股份有限公司	
		CONTACT TECHNOLOGY CORP.	
TOLERANCE UNLESS OTHERWISE STATED :		Up to 5 Above 5 ~ 15 Above 15 ~ 30 Above 30 ~ 50 Angle	± 0.2 ± 0.3 ± 0.4 ± 0.5 $\pm 0.3^\circ$
		3RD. ANGEL'S	
		UNITS	MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	09/08/23	FINISH	MODLE	USB AF SMT 平口 1.0 柱
CHECKED BY:	DATE	SCALE	DWG NO.	SUA-110M15-x-x-S175
Jacky Chen	09/08/23	1 : 1	PART NO.	SUA-110M15-x-x-S175
APPROVED BY:	DATE	SHEET NO.	1 of 1	
Tony Kao	09/08/23			